

Attorney Docket No. 5649-968

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Lee et al.

Serial No.: 10/046,805

Filed: January 14, 2002

For: METHODS OF FORMING METAL LAYERS IN INTEGRATED CIRCUIT  
DEVICES USING SELECTIVE ELECTROPLATING ON EDGES OF  
RECESSES AND CONDUCTIVE CONTACTS SO FORMED

Group Art Unit: 2829

Examiner: Lisa A. Kilday

Confirmation No.: 6423

January 9, 2004

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

AMENDMENT AND SUBMISSION OF TERMINAL DISCLAIMER WITH  
INFORMATION DISCLOSURE STATEMENT

Sir:

This Amendment and Submission is responsive to the Official Action of July  
9, 2003.

Amendments to the Claims are reflected in the listing of claims, which  
begins on page 2 of this paper.

Remarks begin on page 6 of this paper.